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The following journals have been added:

ACM Transactions on Mathematical Software (ACM TRANS MATH SOFTWARE) ISSN 0098-3500, Association for Computing Machinery, 1515 Broadway, New York, NY 10036, Quarterly, \$129.00.

Proceedings of the Institution of Mechanical Engineers Part H—Journal of Engineering in Medicine (PROC INST MECH ENG H) ISSN 0954-4119, Mechanical Engineering Publications Ltd., P.O. Box 24, Northgate Avenue, Bury St. Edmunds, Suffolk, England, IP32 6BW, Bimonthly, \$471.00.

The following journals have been deleted:

Acta Polytechnica Scandinavica—Mechanical Engineering Series Datamation